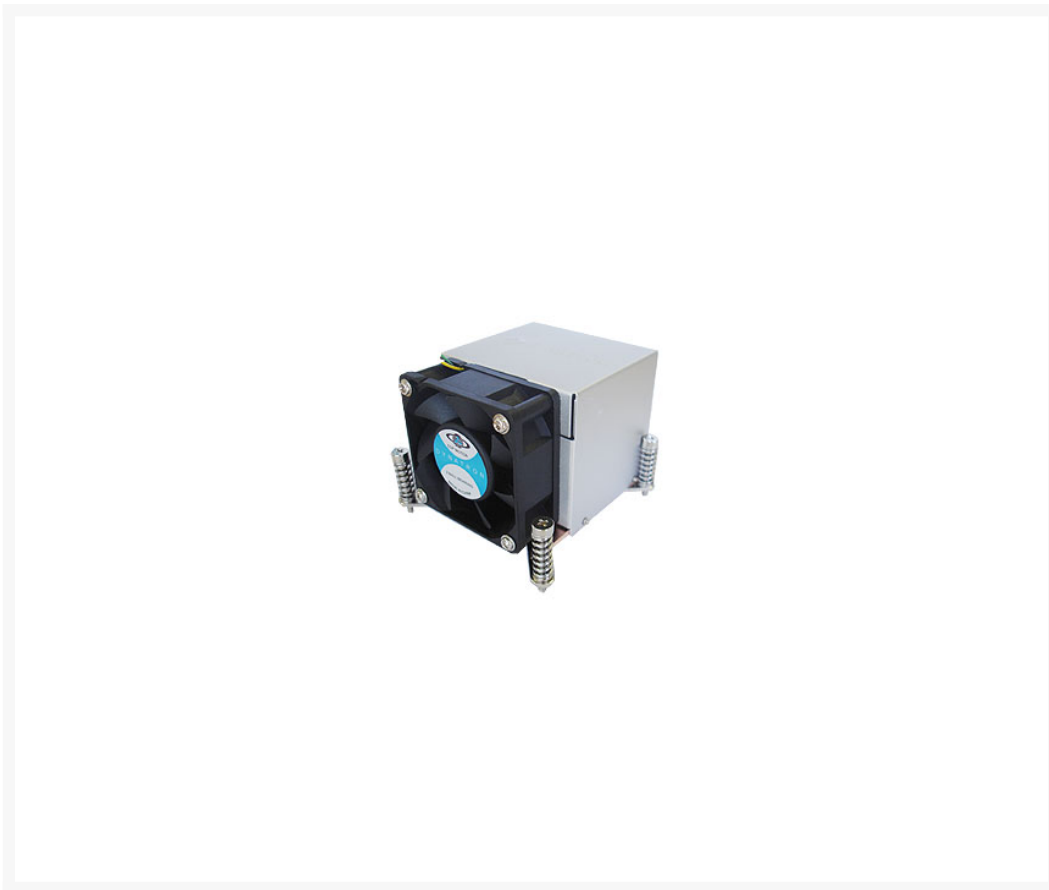


# Dynatron K650 Active Heatsink for 2U Servers - Socket LGA1156

\$29.95

## Product Images



## Short Description

Dynatron Active Heat Sink for 2U Server. Recommend for Intel® Core™ i5 I5-750; Xeon® Processor 3400 Series; Core™ i7 Processors I7-870 & I7-860; Socket LGA1156

## Description

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### Product Details:

Dynatron Active Heat Sink for 2U Server. Recommend for Intel® Core™ i5 I5-750; Xeon® Processor 3400 Series; Core™ i7 Processors I7-870 & I7-860; Socket LGA1156

## Features

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Features:



## Specifications

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Specifications:

CPU Socket 1156



CPU Support Intel® Core™ i5 I5-750; Xeon® Processor 3400 Series; Core™ i7 Processors, I7-870 & I7-860



Solution 2U&Up Server



Overall Dimension 88.5 x 87.0 x 64.0 mm



Weight 460 g



Material Copper Base with Aluminum Stacked Fin



Fan Dimension 60 x 60 x 25 mm



Speed At Duty Cycle 0~20%: 1400 RPM  
At Duty Cycle 50%: 3500 RPM  
At Duty Cycle 100%: 7000 RPM



Bearing 2 Ball Bearing



Rated Voltage 12 V



Power At Duty Cycle 0~20%: 0.6 W  
At Duty Cycle 50%: 1.20 W  
At Duty Cycle 100%: 5.4 W



Air Flow At Duty Cycle 0~20%: 7.405 CFM  
At Duty Cycle 50%: 18.517 CFM  
At Duty Cycle 100%: 38.283 CFM



Noise Level At Duty Cycle 0~20%: 20.8 dBA  
At Duty Cycle 50%: 35.9 dBA  
At Duty Cycle 100%: 48.1 dBA



Air Pressure At Duty Cycle 0~20%: 0.574mm-H2O  
At Duty Cycle 50%: 3.586mm-H2O  
At Duty Cycle 100%: 13.552mm-H2O



Lead Wire Pin Out Pin1-Black (-)  
Pin2-Yellow (+)  
Pin3-Green (Techometer/Signal output)  
Pin4-Blue (PWM)



Thermal Resistance & Noise Level VS. Cooling Fan Speed



Note  
1. Thermal Grease Pre-Printed with GE-Toshiba TIG830SP  
2. RoHS Compliance

## Additional Information

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Brand	Dynatron
SKU	K650-D
Weight	1.0000
Compatibilty	Intel LGA 1156
Material	Copper/Aluminum

